1. Disassembly Procedures

S1 Turn off power

S2 Place the monitor on a soft cloth or cushion

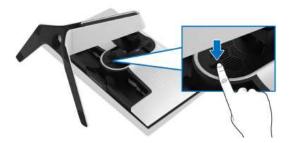
Carefully slide and remove the I/O cover from the monitor.



Disconnect the cables from the monitor and slide them out through the cablemanagement slot on the stand riser.



S4 Press and hold the stand release button



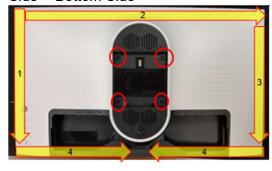
S5 Lift the stand up and away from the monitor.



S6 Unlock 4 screws on rear cover

Use hands or scraper bar to disassemble Rear Cover from the monitor.

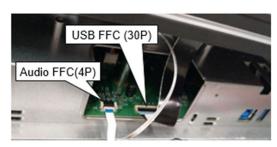
Notice the disassembly order: Left Side=> Top Side=>Right Side=>Bottom Side



(Screw Torque: 8-10 kgf)

Remove USB FFC and Audio FFC from I/F BD

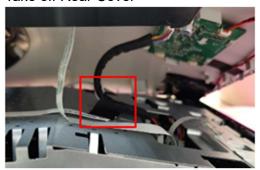




Remove 1 tape on LED Driver BD wire from Main SHD and disconnect LED Driver BD wire from I/F BD

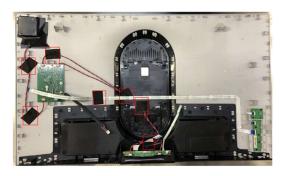
Disconnect CTRL FFC cable from I/F BD and tear it from Main SHD

Take off Rear Cover



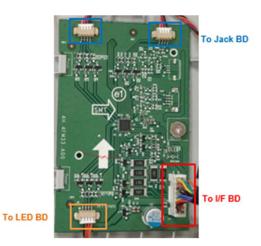


Remove all tapes from cables and Rear Cover



S10 Remove all cables from LED Driver BD

Unlock 1 screw and disassemble LED Driver BD from Rear Cover

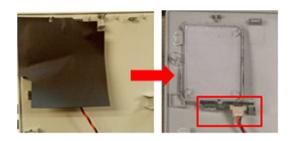


(Screw Torque: 4.5±0.5 kgf)

S11 Tear off "MYLAR HEAD LOGO" from cover LOGO LENS

Disconnect LED wire from LED BD

Disassemble LED BD from Rear Cover



S12 Remove 2 tapes on Jack BD from Rear Cover

Tear off RC Mylar from USB BD and Jack BD



S13 Disassemble Jack BD from Rear Cover

Remove 2 wires from Jack BD

Unlock 2 screws to disassemble USB BD from Rear Cover





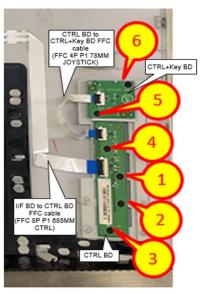
(Screw Torque: 4.5±0.5 kgf)

S14 Disconnect USB FFC and Audio FFC from USB BD



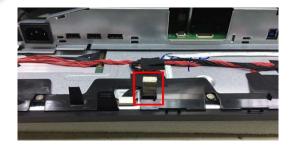
Remove FFC cable from Rear Cover, CTRL BD and CTRL+KEY BD

Unlock 6 screws to disassemble CTRL BD and CTRL+KEY BD from Rear Cover

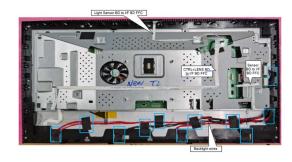


(Screw Torque: 2.0±0.5 kgf)

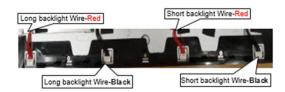
S16 Take off 1 gasket from Middle Frame



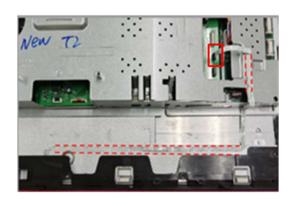
S17 Remove all tapes from Main SHD and Middle Frame



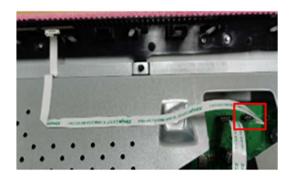
S18 Disconnect Backlight Wires from Panel and SPS+LED BD



S19 Disconnect Sensor BD FFC from I/F BD and tear off it from panel and Main SHD



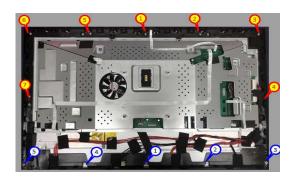
S20 Disconnect Light Sensor BD FFC from I/F BD and tear off it from Panel and Main SHD



S21 Disconnect "CTRL+LENS BD FFC" from I/F BD and tear off it from Panel and Main SHD



S22 Unlock MF screws*7 and inferior screws*5 to disassemble Middle Frame from Panel



(Screw Torque: 4.5±0.5 kgf)

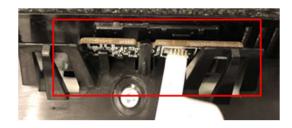
S23 Tear off a yellow tape and an acetate tape from EDP cable and panel

Disconnect EDP cable from Panel

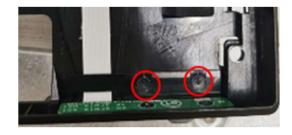
Take off Main SHD from Panel.



S24 Disassemble Light Sensor BD from Middle Frame



S25 Unlock 2 screws to disassemble Power Button module from Middle Frame



(Screw Torque: 1.1±0.1 kgf)

S26 Disconnect FFC cable from "CTRL+LENS BD" (Power CTRL BD)



S27 Tear off "MYLAR PWR-LENS" from "CTRL+LENS BD" (Power CTRL BD)



Unlock 2 screws to disassemble "CTRL+LENS BD" (Power CTRL BD) from Power Button



(Screw Torque: 2±0.5 kgf)

S29 Disassemble Sensor BD from Middle frame



S30 Unlock 1 screw to disassemble Docking BD from Main SHD

Disassemble wire from Docking BD



(Screw Torque: 8.5±1.0 kgf)

S31 Disassemble mylar from Main SHD



Tear off an adhesive tape and a yellow tape from I/F BD and EDP cable

Disconnect EDP cable from I/F BD

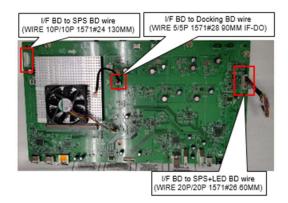


Unlock 11 screws on PCBA to disassemble SPS+LED BD, SPS BD and I/F BD from Main SHD



(Screw Torque: 8.5±1.0 kgf)

S34 Disconnect wires from I/F BD, SPS BD and SPS+LED BD





S35 Unlock 1 ground screw to disassemble AC Socket from Main SHD



(Screw Torque: 8-10 kgf)

S36 Disconnect Fan Cable from I/F BD



S37 Unlock 4 screws to disassemble G-SYNC Module from I/F BD



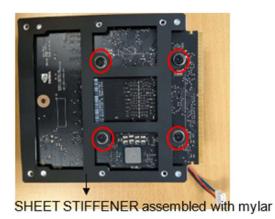
(Screw Torque: 4-4.5 kgf)

Unlock 4 Heat Sink screws and 4 captive screws to disassemble G-Sync module, Heat Sink Module and SHEET STIFFENER

Tear off MYLAR from SHEET STIFFENER



(Screw Torque-Heat Sink: 2-2.5 kgf)



(Screw Torque-Captive screw: 4-4.5 kgf)

S39

Remove electrolyte capacitors (red mark) from printed circuit boards



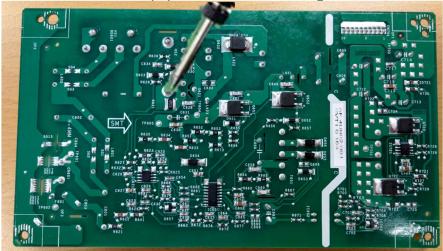
S39-1 Cut the glue between bulk cap. and PCB with a knife



S39-2 Ensure cutting path within the glue, don't touch bulk cap. or PCB



S39-3 Take out bulk cap. pin solder with soldering iron and absorber



S39-4 Lift the bulk cap. up and away from the PCB



2. Product material information

The following substances, preparations, or components should be disposed of or recovered separately from other WEEE in compliance with Article 4 of EU Council Directive 75/442/EEC.

Capacitors / condensers (containing PCB/PCT)	No used
Mercury containing components	No used
Batteries	No used
Printed circuit boards (with a surface greater	Product has printed circuit boards
than 10 square cm)	(with a surface greater than 10 square
	cm)
Component contain toner, ink and liquids	No used
Plastic containing BFR	No used
Component and waste contain asbestos	No used
CRT	No used
Component contain CFC, HCFC, HFC and	No used
HC	
Gas discharge lamps	No used
LCD display > 100 cm2	Product has an LCD greater than 100 cm2
External electric cable	Product has external cables
Component contain refractory ceramic fibers	No used
Component contain radio-active substances	No used
Electrolyte capacitors (height	Product has electrolyte capacitors
> 25mm, diameter > 25mm)	(height >25mm, diameter > 25mm)

3. Tools Required

List the type and size of the tools that would typically can be used to disassemble the product to a point where components and materials requiring selective treatment can be removed.

Tool Description:

- Screwdriver
- Scraper Bar
- Penknife
- Soldering iron and absorber